	DSC	4005
Tentative	Total pages	page

DSC4005

Silicon NPN epitaxial planar type

For general amplifier

Marking Symbol : C3

Package Code : NS-B1-B-B

Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	60	V
Collector-emitter voltage (Base open)	VCEO	50	V
Emitter-base voltage (Collector open)	VEBO	6	V
Collector current	IC	200	mA
Peak collector current	ICp	300	mA
Collector power dissipation	Pc	300	mW
Junction temperature	Tj	150	С°
Storage temperature	Tstg	-55 to +150	С°

	1.	Emitter
Pin name	2.	Collector
	3.	Base

Electrical Characteristics Ta = 25 °C±3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	VCEO	IC = 100 µ A, IB = 0	50			V
Collector-base cutoff current (Emitter open)	ICBO	VCB = 60 V, IE = 0			0.1	μA
Emitter-base cutoff current (Collector open)	IEBO	VEB = 6 V, IC = 0			0.1	μA
Forward current transfer ratio ^{*1}	hFE1	VCE = 6 V, IC = 1 mA	150		390	-
Forward current transfer ratio	hFE2	VCE = 6 V, IC = 0.1mA	90			-
Collector-emitter saturation voltage	VCE(sat)	IC = 100 mA, IB = 10 mA			0.3	V
Transition frequency	fT	VCE = 6 V, IC = 10 mA		200		MHz
Collector output capacitance (Common base, input open circuited)	Cob	VCB = 6 V, IE = 0, f = 1 MHz		3.5		pF

Note: Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

*1: Rank classification

turne olabolitou									
Code		R			S			0	
Rank		R			S		N	o-rai	nk
hFE1	150	to	270	200	to	390	150	to	390
Marking symbol		C3R			C3S			C3	

Product of no-rank is not classified and have no marking symbol for rank.

Packing

Radial type: 5 000 pcs / carton

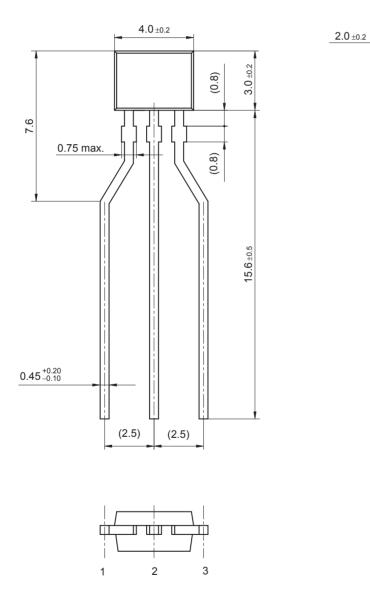
2010.2.23	2010.9.10
Prepared	Revised

NS-B1-B-B

Unit: mm

 $0.45 \, {}^{+0.20}_{-0.10}$

0.7 ±0.1



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